# **WS-3622**Ball-Attach Flux

#### Introduction

**Ball-Attach Flux WS-3622** is a thixotropic flux designed for use in pin transfer applications for ball-attachment to substrates (BGA manufacturing). Its rheology is specifically designed for use with even the smallest gravity-fed spheres. **WS-3622** has an activator system powerful enough to promote wetting on the most demanding substrate metallizations. The flux is a distinctive red color, which aids automated level-sensing equipment and also enhances visual inspection.

#### **Features**

- Uniform pin transfer over extended periods
- Proven high yields in ball-attach process
- Suitable for Pb-free or Sn/Pb applications
- Flux rheology applicable for all sphere sizes
- · Red color for ease of detection
- · Excellent solderability on a wide range of surfaces
- · Bubble-free packaging

### **Properties**

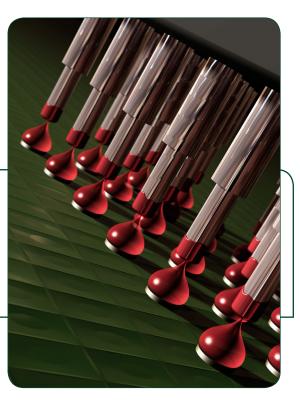
	Value	Test Method
Flux Type Classification	H1	J-STD-004 (IPC-TM-650: 2.3.32 and 2.3.33)
Typical Viscosity	9kcps	Brookfield HB DVII ± CP (5rpm)
SIR (Ohms, after reflow)	Pass (>10 <sup>8</sup> after 7 days @ 85°C and 85% RH)	J-STD-004 (IPC-TM-650: 2.6.3.3 IPC-B-24)
Typical Acid Value	71mg KOH/g	Titration
Typical Tack Strength	570g	J-STD-005 (IPC-TM-650: 2.4.44)
Shelf Life	6 months (-20 to +5°C)	Viscosity change/ microscope examination

All information is for reference only.

Not to be used as incoming product specifications.

# **Application**

The amount of flux deposited on the substrate can be optimized by changing equipment parameters. Key variables include pin shape, pin diameter, shear speed, dwell, and depth of immersion. The flux rheology can be optimized for the desired application by shearing to achieve the desired viscosity.



## **Cleaning**

**WS-3622** residue can be cleaned with DI water, or water with an added cleaner. Ideal conditions for spray-cleaning: 25°C (room temperature) or higher for >1 minute at >60psi.

# **Packaging**

WS-3622 is available in 10cc and 30cc syringes.





#### **PRODUCT DATA SHEET**

# **WS-3622 Ball-Attach Flux**

#### **Storage**

For maximum shelf life, **WS-3622** syringes and cartridges should be stored tip down. Storage temperatures should not exceed 30°C. After removing from cold storage, **WS-3622** should be allowed to stand for at least 4 hours at room temperature before using.

### **Technical Support**

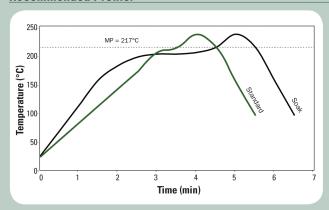
Indium Corporation sets the industry standard in providing rapid response, onsite technical support for our customers worldwide. Indium Corporation's team of Technical Support Engineers can provide expertise in all aspects of Materials Science and Semiconductor Packaging process applications.

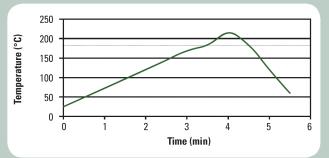
### **Safety Data Sheets**

The SDS for this product can be found online at http://www.indium.com/sds

#### Reflow

#### **Recommended Profile:**





Peak reflow temperature should be <350°C in an air or nitrogen atmosphere (<500ppm  $O_2$ ), with a linear ramp up to 30°C above liquidus temperature. These profiles are recommended to the user as starting points, and should be optimized by the user to meet their individual process needs.

This product data sheet is provided for general information only. It is not intended, and shall not be construed, to warrant or guarantee the performance of the products described which are sold subject exclusively to written warranties and limitations thereon included in product packaging and invoices. All Indium Corporation's products and solutions are designed to be commercially available unless specifically stated otherwise.

Contact our engineers today: askus@indium.com

Learn more: www.indium.com

ISO 9001 REGISTERED

